



本社：〒160-8366
東京都新宿区西新宿 6 丁目 24 番 1 号
西新宿三井ビルディング

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お客様各位

日本テキサス・インスツルメンツ株式会社
営業・技術本部 カスタムドキュメント
マネージャ 牧 達郎 

SOT/SSOP/MSOP/SOIC パッケージ 一部製品 組立検査サイト追加のご案内

平素は弊社製品のご愛顧を賜り、厚くお礼申し上げます。さて、標題の件につきましてご連絡させていただきます。ご査収の程、宜しく願い申し上げます。

タイにおける大洪水の影響により、HANA 社(タイ)サイトを含む数カ所の弊社協力工場における生産が、暫定的に被害を受けております。

TI は、連日、生産/流通拠点パートナーからの状況連絡を受けながら、供給面での致命的影響を緩和する為に、代替製造工場の選定及び認定を含む様々な施策を行っております。

今回のお知らせは、代替組立検査工場追加の連絡になります。お客様への供給停滞を最小限にとどめる為に、本通知内で明記したパッケージ製品について、既に認定されている工場への生産移管に向け早急に対応いたしております。

TI は、現行最善の情報/知識に基づき生産移管に必要な全てを本通知に盛り込むべく全ての方策を行っていますが、変更があった場合にも同様に本通知の更新版にて連絡いたします。さらに、選定された代替工場をより効率的に利用できると判断した時点で、これらに関連する供給移管に伴う PCN を発行する場合があります。

TI は、各生産拠点での認定状況を基に生産拠点選定及びパッケージ認定試験による前述の移管施策に加え、お客様への製品納入に先立ち、選別工程での歩留まり/選別分類比較評価を行う事でお客様での懸念事項の払拭に向け進めてまいります。また、供給の遅れを最小限にとどめると共に、品質を伴った製品の供給に努めてまいります。

次ページに詳細を掲載いたしました。お客様におかれましては、本通知発行日より **21 日以内**に、本通知受領のご確認をお願いいたします。供給遅延を最小限にとどめるために、TI は部材供給可能な代替工場での生産を 12 月の出荷が開始されるべくすでに施策の実施を開始しております。

本通知は、通知日前 24 ヶ月以内に本変更対象製品をご購入いただいたお客様に連絡させていただいております。

ご不明な点、ご質問等がございましたら、担当営業あるいは pcn_tij@list.ti.com にお問い合わせ下さい。

以上

変更概要

通知タイプ	☐ Initial notice (Plan)	☒ Final notice		
変更概要	Design/Specification	☐ Design	☐ Electrical	☐ Mechanical
	Wafer Fab	☐ Site	☐ Process	☐ Material
	Wafer Bump	☐ Site	☐ Process	☐ Material
	☒ Assembly	☒ Site	☐ Process	☒ Material
	☒ Test	☒ Site	☐ Process	
	☒ Others	☒ Packing/Shipping/Labeling ☐ -		
変更内容	SOT/SSOP/MSOP/SOIC パッケージ 一部製品 組立検査サイト追加 現行 : HANA 社(タイ) 変更後 : HANA 社(タイ), UTAC2 社(タイ), NFME 社(中国), ASE 社(上海), ASE 社(威海)			
対象製品	対象製品リスト参照			
変更時期	12 月の出荷より予定しています。			
品質認定試験	☐ 計画	☒ 終了		
製品表示	☐ 変更無し	☒ 変更あり		
備考	-			

変更内容

内容 : SOT/SSOP/MSOP/SOICパッケージ 一部製品の組立検査サイトについて、現行 HANA社(タイ)サイトに製造していますが、HANA社(タイ)サイト一時的閉鎖による供給能力確保の為に、これに加えて、UTAC2社(タイ), NFME社(中国), ASE社(上海, 中国), ASE社(威海, 中国)サイトを追加します。組立部材、検査サイトについては下記の通り変更されます。下表を参照下さい。尚、今回の変更で、製品についての互換性(寸法/公差), 外観, 動作特性, 品質, 信頼性への影響はありません。

変更内容	現行	変更後
組立検査サイト	HANA社(タイ)	HANA社(タイ) UTAC2社(タイ) NFME社(中国) ASE社(上海, 中国) ASE社(威海, 中国)

理由 : HANA 社(タイ)サイト一時的閉鎖による供給能力確保の為

詳細：

PKG	参照 Qual#	組立 サイト	モールド樹脂	チップ接着剤	Au ボンディングワイヤ (径, 部材)
DBV	#1	HNT	R-13	PZ0013	0.6, 1.0 mil, Au
		NFME	R-13	A-03	0.8, 1.0 mil, Au
DCK	#2	HNT	R-13	A-09, PZ0013	0.6, 0.8, 1.0 mil, Au
		NFME	R-07	A-03, A-09	0.8, 1.0 mil, Au
DCY	#3	HNT	R-13	PZ0013, A-09, 400159	1.0, 1.5, 2.0 mil, Au
		NFME	R-07, R-17	A-06, A-09	1.0, 2.0 mil, Au
DBZ	#6	HNT	R-13	PZ-0013	1.0 mil, Au
		NS2	R-13	A-09	1.0 mil, Au
DBV	#4	HNT	R-13	PZ0013	0.6, 1.0 mil, Au
		NS2	R-13	A-09, PZ0013, PZ0001, PZ0017	0.6, 1.0 mil, Au
DCK	#5	HNT	R-13	A-09, PZ0013	1.0 mil, Au
		NS2	R-13	A-09, PZ0001	1.0 mil, Au
DDC	#8	HNT	R-13	400151	1.0 mil, Au
		NS2	R-13	PZ0013	1.0 mil, Au
DCN	#7	HNT	R-13	A-09, PZ0013	1.0 mil, Au
		NS2	R-13	A-09, PZ001	1.0 mil, Au
DGK	#12	HNT	R-13, EN2000601	PZ0013	1.0 mil, Au
		NS2	R-13	PZ0013	0.8, 1.0, 1.3 mil, Au
DGN	#12	HNT	R-13	PZ0013	1.0, 1.25 mil, Au
		NS2	R13	PZ0013	0.8, 1.0, 1.3, 2.0 mil, Au
DGQ	#12	HNT	R-13	PZ0013	1.0, 1.25 mil, Au
		NS2	R-13	PZ0013	0.8, 1.0, 1.3, 2.0 mil, Au
DGS	#12	HNT	R-13	PZ0013	1.0 mil, Au
		NS2	R-13	PZ0013	0.8, 1.0, 1.3, 2.0 mil, Au
DBZ	#11	HNT	R-13	PZ0013	1.0 mil, Au
		ASEWH	R-13	1120999A1	1.0 mil, Au
DBV	#9	HNT	R-13	PZ0013	0.6, 1.0 mil, Au
		ASEWH	R-13	C990J#316	0.8, 1.0 mil, Au
DCK	#10	HNT	R-13	A-09	0.8, 1.0 mil, Au
		ASEWH	R-13	1120999A1	0.8, 1.0 mil, Au
DDA	#13	HNT	R-13	400159	1.0, 1.3, 2.0 mil, Au
		ASESH	EN2000509	EY100063	1.0, 2.0 mil, Cu
DGK	#14	HNT	R-13, EN2000631	PZ0013, 400018	1.0 mil, Au
		ASESH	EN2000515, EN2000631	EY100063	1.0, 1.2, 1.3, 1.5, 2.0 mil, Au
DGN	#14	HNT	R-13	PZ0013	1.0, 1.2, 1.3, 1.5, 2.0 mil, Au
		ASESH	EN2000515	EY100063	1.0, 1.2, 1.3, 1.5, 2.0 mil, Au
DGQ	#14	HNT	R-13	PZ0013	1.0, 1.25 mil, Au
		ASESH	EN2000515	EY100063	1.0, 1.2, 1.3, 1.5, 2.0 mil, Au
DGS	#14	HNT	R-13	PZ0013	1.0, 1.2, 1.3, 1.5, 2.0 mil, Au
		ASESH	EN2000515, EN2000631	EY100063	1.0, 1.2, 1.3, 1.5, 2.0 mil, Au
The Leadframe finish for all devices at ASESH will be NiPdAuAg, at HNT they are all NiPdAu.					

表 1 変更組立部材

	追加検査サイト							
Package	NFME	NS2	ASEWH	ASESH	TIM	TAI	LEN	CRS
DBV	✓	☐	✓	☐	☐	☐	☐	✓
DBZ	☐	✓	☐	☐	☐	☐	☐	☐
DCK	✓	✓	✓	☐	☐	☐	✓	✓
DCN	☐	✓	☐	☐	☐	☐	☐	✓
DCY	✓	☐	☐	☐	☐	☐	☐	☐
DDA	☐	☐	☐	✓	✓	☐	☐	☐
DDC	☐	✓	☐	☐	☐	☐	☐	☐
DGK	☐	☐	☐	✓	✓	✓	☐	☐
DGN	☐	☐	☐	✓	✓	✓	☐	☐
DGQ	☐	✓	☐	☐	✓	☐	✓	☐
DGS	☐	☐	☐	✓	✓	✓	☐	☐

表2 追加検査サイト

備考：

HNT: HANA 社(タイ)
 NFME: NFME 社(中国)
 NS2: UTAC2 社(タイ)
 ASEWH: ASE 社(威海, 中国)
 ASESH: ASE 社(上海, 中国)
 TIM: TI-Malaysia(マレーシア)
 TAI: TI-Taiwan(台湾)
 LEN: Lingsen 社(台湾)
 CRS: CARSEM-S 社(CRS, マレーシア)

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対象製品リスト

対象製品名
現行組立サイト: NFME

74AUC1G126DBVRE4	INA212AIDCKT	SN74AUP1G07DBVRG4	SN74LVC1G58DBVRG4	TPS79718DCKRG4
74AUC1G126DBVRG4	INA212AIDCKTG4	SN74AUP1G08DBVR	SN74LVC2G06DBVR	TPS79730DCKR
74AUC1G240DBVRE4	INA213AIDCKR	SN74AUP1G08DBVRE4	SN74LVC2G06DBVRE4	TPS79730DCKRG4
74AUC1G240DBVRG4	INA213AIDCKRG4	SN74AUP1G08DBVRG4	SN74LVC2G06DBVRG4	TPS79733DCKR
74AVCH1T45DBVRE4	INA214AIDCKR	SN74AUP1G58DCKRG4	SN74LVC2G06DCKRG4	TPS79733DCKRG4
74AVCH1T45DBVRG4	INA214AIDCKRG4	SN74AUP1G80DBVT	TLV1117LV15DCYR	TS12A4516DBVR
74AVCH1T45DBVTE4	LMV981IDCKRG4	SN74AUP1G80DBVTE4	TLV1117LV25DCYR	TS12A4517DBVR
74AVCH1T45DBVTG4	OPA140AIDBVR	SN74AUP1G80DBVTG4	TLV70220PDBVR	TS321IDBVR
74AVCH1T45DCKRG4	OPA140AIDBVT	SN74AUP1G97DBVR	TLV7211AIDCKR	TS321IDBVRE4
74AVCH1T45DCKTG4	OPA171AIDBVT	SN74AUP1G97DBVRE4	TLV7211AIDCKRG4	TS321IDBVRG4
74CB3T1G125DBVRE4	OPA322AIDBVR	SN74AUP1G97DBVRG4	TMP20AIDCKR	TS5A1066DBVR
74CB3T1G125DBVRG4	OPA376AIDBVR	SN74AUP1T57DBVR	TPD4S009DCKR	TS5A1066DBVRE4
74CBT1G125DBVRE4	OPA376AIDBVRG4	SN74AUP1T57DBVRE4	TPD4S009DCKRG4	TS5A1066DBVRG4
74CBT1G125DBVRG4	REG1117	SN74AUP1T57DBVRG4	TPL0401A-10DCKR	TS5A3157DBVR
74CBT1G384DBVRE4	REG1117/2K5	SN74AUP1T57DCKRG4	TPL0401B-10DCKR	TS5A3157DBVRE4
74CBT1G384DBVRG4	REG1117/2K5G4	SN74AUP1T58DCKRG4	TPS3800G27DCKR	TS5A3157DBVRG4
74CBTD1G125DBVRE4	REG1117-5/2K5	SN74AUP1T97DBVT	TPS3800G27DCKRG4	TS5A3160DBVR
74CBTD1G125DBVRG4	REG1117-5/2K5G4	SN74AUP1T97DBVTE4	TPS3801-01DCKR	TS5A3160DBVRE4
74CBTD1G384DBVRE4	REG1117A/2K5	SN74AUP1T97DBVTG4	TPS3801-01DCKRG4	TS5A3160DBVRG4
74CBTD1G384DBVRG4	REG1117A/2K5G4	SN74AUP1T97DCKRG4	TPS3801E18DCKR	TS5A3160DCKJ
74LVC1G132DBVRE4	REG1117G4	SN74AVC1T45DBVR	TPS3801E18DCKRG4	TS5A3160DCKR
74LVC1G132DBVRG4	SN0710019DCKR	SN74AVC1T45DBVRE4	TPS3801K33DCKR	TS5A3160DCKRE4
74LVC1G132DCKRG4	SN1105002DCKR	SN74AVC1T45DBVRG4	TPS3801K33DCKRG4	TS5A3160DCKRG4
74LVC1G3208DBVRG4	SN200602108DCKR	SN74AVC1T45DCKRG4	TPS3801T50DCKR	TS5A3166DBVR
74LVC1G373DBVRE4	SN200602108DCKRG4	SN74AVCH1T45DBVR	TPS3801T50DCKRG4	TS5A3166DBVRE4
74LVC1GX04DCKRG4	SN74AUC1G00DBVR	SN74AVCH1T45DBVT	TPS3802K33DCKR	TS5A3166DBVRG4
HPA00328DCKR	SN74AUC1G00DBVRE4	SN74CB3T1G125DBVR	TPS3802K33DCKRG4	TS5A3167DBVR
HPA00366DCKR	SN74AUC1G00DBVRG4	SN74CBT1G125DBVR	TPS3802L30DCKR	TS5A3167DBVRE4
HPA00422DCKR	SN74AUC1G02DCKR	SN74CBT1G384DBVR	TPS3802L30DCKRG4	TS5A3167DBVRG4
HPA00423DCKR	SN74AUC1G02DCKRE4	SN74CBTD1G125DBVR	TPS3803-01DCKR	TS5A4594DBVR
HPA00456DCKR	SN74AUC1G02DCKRG4	SN74CBTD1G384DBVR	TPS3803-01DCKRG4	TS5A4594DBVRE4
HPA00528DCKR	SN74AUC1G07DBVR	SN74LVC1G0832DBVR	TPS3805H33DCKR	TS5A4594DBVRG4
HPA00579DCKR	SN74AUC1G07DBVRE4	SN74LVC1G132DBVR	TPS3805H33DCKRG4	TS5A4597DBVR
HPA00653DCKR	SN74AUC1G07DBVRG4	SN74LVC1G132DBVT	TPS71501DCKR	TS5A4597DBVRE4
HPA00681DCKR	SN74AUC1G126DBVR	SN74LVC1G132DBVTE4	TPS71501DCKR/2801	TS5A4597DBVRG4
HPA00683DCKR	SN74AUC1G14DBVR	SN74LVC1G132DBVTG4	TPS71501DCKRG4	TS5A4624DCKR
HPA00763DCKR	SN74AUC1G14DBVRE4	SN74LVC1G132DCKR	TPS71523DCKR	TS5A4624DCKRE4
HPA01091DBVR	SN74AUC1G14DBVRG4	SN74LVC1G18DBVR	TPS71523DCKRG4	TS5A4624DCKRG4
INA199A1DCKR	SN74AUC1G240DBVR	SN74LVC1G18DBVRE4	TPS71525DCKR	TS5A4624DCKT
INA199A2DCKR	SN74AUC1G32DBVR	SN74LVC1G18DBVRG4	TPS71525DCKRG4	TS5A4624DCKTE4
INA199A2DCKT	SN74AUC1G32DBVRE4	SN74LVC1G27DCKRG4	TPS71530DCKR	TS5A4624DCKTG4
INA199A3DCKR	SN74AUC1G32DBVRG4	SN74LVC1G3208DBVR	TPS71530DCKRG4	TXB0101DBVR
INA210A1DCKR	SN74AUC2G04DCKRG4	SN74LVC1G373DBVR	TPS71533DCKR	TXB0101DBVRG4
INA210A1DCKRG4	SN74AUC2G07DBVR	SN74LVC1G38DBVR	TPS71533DCKRG4	TXS0101DBVR
INA211A1DCKR	SN74AUC2G07DBVRE4	SN74LVC1G38DBVRE4	TPS71550DCKR	TXS0101DBVRG4
INA211A1DCKRG4	SN74AUC2G07DBVRG4	SN74LVC1G38DBVRG4	TPS71550DCKR/2801	
INA211A1DCKT	SN74AUP1G07DBVR	SN74LVC1G58DBVR	TPS71550DCKRG4	
INA211A1DCKTG4	SN74AUP1G07DBVRE4	SN74LVC1G58DBVRE4	TPS79718DCKR	

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対象製品名 現行組立サイト: UTAC2				
74AUC1G126DBVRE4	SN65HVD3082EDGKR	THS4211DGKG4	TPA311DGN4	TPS62052DGSR
74AUC1G126DBVRG4	SN65HVD3085EDGKR	THS4500IDGK	TPA311DGNR	TPS62052DGSRG4
74AUC1G240DBVRE4	SN65HVD3085EDGKRG4	THS4500IDGKG4	TPA311DGNRG4	TPS62054DGS
74AUC1G240DBVRG4	SN65HVD3088EDGK	THS4500IDGNR	TPA321DGNR	TPS62054DGS4
74AVCH1T45DBVRE4	SN65HVD3088EDGKG4	THS4500IDGNRG4	TPA321DGNRG4	TPS62054DGSR
74AVCH1T45DBVRG4	SN65HVD3088EDGKR	THS4502CDGN	TPA6100A2DGKR	TPS62054DGSRG4
74AVCH1T45DBVTE4	SN65HVD3088EDGKRG4	THS4502CDGNG4	TPA6100A2DGKRG4	TPS62056DGS
74AVCH1T45DBVTG4	SN65HVD485EDGKR	THS4502IDGN	TPA6110A2DGNR	TPS62056DGS4
74AVCH1T45DCKRG4	SN65HVD485EDGKRG4	THS4502IDGNG4	TPA6110A2DGNRG4	TPS62056DGSR
74AVCH1T45DCKTG4	SN65LVDM176DGK	THS4502IDGNR	TPA701DGN	TPS62056DGSRG4
74CB3T1G125DBVRE4	SN65LVDM176DGKG4	THS4502IDGNRG4	TPA701DGN4	TPS62120DCNR
74CB3T1G125DBVRG4	SN65LVDM176DGKR	THS4503CDGNR	TPA701DGNR	TPS62120DCNT
74CBT1G125DBVRE4	SN65LVDM176DGKRG4	THS4503CDGNG4	TPA701DGNRG4	TPS62220DDCR
74CBT1G125DBVRG4	SN65LVDS100DGK	THS4503IDGNR	TPA711DGN	TPS62220DDCRG4
74CBT1G384DBVRE4	SN65LVDS100DGKG4	THS4503IDGNRG4	TPA711DGN4	TPS62220DDCT
74CBT1G384DBVRG4	SN65LVDS100DGKR	THS4505DGN	TPA711DGNR	TPS62220DDCTG4
74CBTD1G125DBVRE4	SN65LVDS100DGKRG4	THS4505DGN4	TPA711DGNRG4	TPS62221DDCR
74CBTD1G125DBVRG4	SN65LVDS179DGK	THS4505DGNR	TPA721DGNR	TPS62221DDCRG4
74CBTD1G384DBVRE4	SN65LVDS179DGKG4	THS4505DGNRG4	TPA721DGNRG4	TPS62221DDCT
74CBTD1G384DBVRG4	SN65LVDS179DGKR	THS4631DGN	TPA731DGN	TPS62221DDCTG4
74LVC1G132DBVRE4	SN65LVDS179DGKRG4	THS4631DGN4	TPA731DGN4	TPS62222DDCR
74LVC1G132DBVRG4	SN65LVDS9637DGKR	THS4631DGNR	TPA731DGNR	TPS62222DDCRG4
74LVC1G132DCKRG4	SN65LVDS9637DGKRG4	THS4631DGNRG4	TPA731DGNRG4	TPS62222DDCT
74LVC1G3208DBVRG4	SN65LVDS9638DGKR	THS6072IDGNR	TPA741DGNR	TPS62222DDCTG4
74LVC1G373DBVRE4	SN65LVDS9638DGKRG4	THS6072IDGNRG4	TPA741DGNRG4	TPS62223DDCT
74LVC1GX04DCKRG4	SN65LVD100DGKR	TLC0711DGNR	TPD2E009DBZR	TPS62223DDCTG4
BQ24202DGN	SN65LVD100DGKRG4	TLC0711DGNRG4	TPD4S009DCKR	TPS62224DDCR
BQ24202DGN4	SN65LVD101DGKR	TLC072CDGNR	TPD4S009DCKRG4	TPS62224DDCRG4
DAC75541DGS	SN65LVD101DGKRG4	TLC072CDGNG4	TPD4S009DGSR	TPS62224DDCT
DAC75541DGS4	SN65LVEL11DGKR	TLC0721DGN	TPL0401A-10DCKR	TPS62224DDCTG4
DAC75541DGSR	SN65LVELT23DGKR	TLC0721DGN4	TPL0401B-10DCKR	TPS62225DDCR
DAC75541DGSRG4	SN65LVEP11DGK	TLC0721DGNR	TPL0501-100DCNR	TPS62227DDCR
DAC85511ADGKR	SN74AUC1G00DBVR	TLC0721DGNRG4	TPS22960DCNR	TPS62227DDCRG4
DAC85511ADGKRG4	SN74AUC1G00DBVRE4	TLC073CDGQ	TPS3305-33DGNR	TPS62227DDCT
DAC85511ADGKT	SN74AUC1G00DBVRG4	TLC073CDGQ4	TPS3305-33DGNRG4	TPS62227DDCTG4
DAC85511ADGKTG4	SN74AUC1G02DCKR	TLC0731DGQR	TPS3306-15DGKR	TPS62228DDCR
DAC85511DGKR	SN74AUC1G02DCKRE4	TLC0731DGQRG4	TPS3306-15DGKRG4	TPS62228DDCRG4
DAC85511DGKRG4	SN74AUC1G02DCKRG4	TLC081CDGNR	TPS3306-18DGKR	TPS62228DDCT
DAC85511DGKT	SN74AUC1G07DBVR	TLC081CDGNG4	TPS3306-18DGKRG4	TPS62228DDCTG4
DAC85511DGKTG4	SN74AUC1G07DBVRE4	TLC081IDGNR	TPS3307-18DGNR	TPS62229DDCT
DRV8830DGQR	SN74AUC1G07DBVRG4	TLC081IDGNRG4	TPS3307-18DGNRG4	TPS62229DDCTG4
DRV8832DGQR	SN74AUC1G126DBVR	TLC082IDGNR	TPS3617-50DGKR	TPS71501DCKR
HPA00107DDCR	SN74AUC1G14DBVR	TLC082IDGNRG4	TPS3617-50DGKRG4	TPS71501DCKR/2801
HPA00210DGSR	SN74AUC1G14DBVRE4	TLC083IDGQ	TPS3619-33DGKR	TPS71501DCKRG4
HPA00245DGSR	SN74AUC1G14DBVRG4	TLC083IDGQ4	TPS3619-33DGKRG4	TPS71523DCKR
HPA00296DGSR	SN74AUC1G240DBVR	TLV2242IDGK	TPS3620-33DGKR	TPS71523DCKRG4
HPA00305DDCR	SN74AUC1G32DBVR	TLV2242IDGKG4	TPS3620-33DGKRG4	TPS71525DCKR
HPA00328DCKR	SN74AUC1G32DBVRE4	TLV2242IDGKR	TPS3620-33DGKT	TPS71525DCKRG4
HPA00366DCKR	SN74AUC1G32DBVRG4	TLV2242IDGKRG4	TPS3620-33DGKTG4	TPS71530DCKR
HPA00422DCKR	SN74AUC2G04DCKRG4	TLV2373IDGSR	TPS3705-33DGNR	TPS71530DCKRG4
HPA00423DCKR	SN74AUC2G07DBVR	TLV2373IDGSRG4	TPS3705-33DGNRG4	TPS71533DCKR
HPA00456DCKR	SN74AUC2G07DBVRE4	TLV2402CDGK	TPS3707-30DGNR	TPS71533DCKRG4
HPA00528DCKR	SN74AUC2G07DBVRG4	TLV2402CDGKG4	TPS3707-30DGNRG4	TPS71550DCKR

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HPA00579DCKR	SN74AUP1G07DBVR	TLV2402CDGKR	TPS3707-33DGNR	TPS71550DCKR/2801
HPA00653DCKR	SN74AUP1G07DBVRE4	TLV2402CDGKRG4	TPS3707-33DGNRG4	TPS71550DCKRG4
HPA00657DGNR	SN74AUP1G07DBVRG4	TLV2402IDGKR	TPS3800G27DCKR	TPS77133DGKR
HPA00681DCKR	SN74AUP1G08DBVR	TLV2402IDGKRG4	TPS3800G27DCKRG4	TPS77133DGKRG4
HPA00683DCKR	SN74AUP1G08DBVRE4	TLV2452CDGK	TPS3801-01DCKR	TPS77301DGKR
HPA00763DCKR	SN74AUP1G08DBVRG4	TLV2452CDGKRG4	TPS3801-01DCKRG4	TPS77301DGKRG4
HPA01090DGNR	SN74AUP1G58DCKRG4	TLV2452CDGKR	TPS3801E18DCKR	TPS77401DGKR
HPA01091DBVR	SN74AUP1G80DBVT	TLV2452CDGKRG4	TPS3801E18DCKRG4	TPS77401DGKRG4
INA199A1DCKR	SN74AUP1G80DBVTE4	TLV2452IDGKR	TPS3801K33DCKR	TPS77901DGKR
INA199A2DCKR	SN74AUP1G80DBVTG4	TLV2452IDGKRG4	TPS3801K33DCKRG4	TPS77901DGKRG4
INA199A2DCKT	SN74AUP1G97DBVR	TLV2453CDGSR	TPS3801T50DCKR	TPS79401DGNR
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INA210A1DCKR	SN74AUP1G97DBVRG4	TLV2453IDGSR	TPS3802K33DCKR	TPS79425DGNR
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INA211A1DCKRG4	SN74AUP1T57DBVRG4	TLV2463CDGSRG4	TPS3802L30DCKRG4	TPS79433DGNRG4
INA211A1DCKT	SN74AUP1T57DCKRG4	TLV2463IDGS	TPS3803-01DCKR	TPS79718DCKR
INA211A1DCKTG4	SN74AUP1T58DCKRG4	TLV2463IDGSG4	TPS3803-01DCKRG4	TPS79718DCKRG4
INA212A1DCKT	SN74AUP1T97DBVT	TLV2463IDGSR	TPS3805H33DCKR	TPS79730DCKR
INA212A1DCKTG4	SN74AUP1T97DBVTE4	TLV2463IDGSRG4	TPS3805H33DCKRG4	TPS79730DCKRG4
INA213A1DCKR	SN74AUP1T97DBVTG4	TLV2472CDGSR	TPS60200DGS	TPS79733DCKR
INA213A1DCKRG4	SN74AUP1T97DCKRG4	TLV2472CDGSRG4	TPS60200DGSRG4	TPS79733DCKRG4
INA214A1DCKR	SN74AVC1T45DBVR	TLV2472IDGSR	TPS60201DGS	TPS7A3001DGNR
INA214A1DCKRG4	SN74AVC1T45DBVRE4	TLV2472IDGSRG4	TPS60201DGSRG4	TPS7A4901DGNR
INA826A1DGK	SN74AVC1T45DBVRG4	TLV2473CDGSR	TPS60203DGS	TPS7A4901DGNR
INA826A1DGKR	SN74AVC1T45DCKRG4	TLV2473CDGSRG4	TPS60203DGSRG4	TPS92510DGQ
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LMV342IDGKRG4	SN74AVCH1T45DBVT	TLV2622IDGKRG4	TPS60204DGSRG4	TS12A12511DCNR
LMV981IDCKRG4	SN74CB3T1G125DBVR	TLV272CDGKR	TPS60204DGSR	TS12A4516DBVR
LPV358DGKR	SN74CBT1G125DBVR	TLV272CDGKRG4	TPS60204DGSRG4	TS12A4517DBVR
LPV358DGKRG4	SN74CBT1G384DBVR	TLV2762IDGKR	TPS60205DGSR	TS3211DBVR
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OPA140A1DBVT	SN74CBTD1G384DBVR	TLV2770IDGKR	TPS60210DGS	TS3211DBVRG4
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OPA1602A1DGKR	SN74LVC1G132DBVR	TLV2772CDGKR	TPS60210DGSR	TS3A24159DGSRG4
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OPA1632DGNRG4	SN74LVC1G132DBVTE4	TLV2782CDGK	TPS60211DGS	TS3A4741DGKR
OPA1632DGNR	SN74LVC1G132DBVTG4	TLV2782CDGKRG4	TPS60211DGSRG4	TS3A4741DGKRG4
OPA1632DGNRG4	SN74LVC1G132DCKR	TLV2782CDGKR	TPS60212DGSR	TS3A4742DCNR
OPA1641A1DGKR	SN74LVC1G18DBVR	TLV2782CDGKRG4	TPS60212DGSRG4	TS3A4742DGKR
OPA1641A1DGKT	SN74LVC1G18DBVRE4	TLV2782IDGKR	TPS60300DGS	TS3A4742DGKRG4
OPA171A1DBVT	SN74LVC1G18DBVRG4	TLV2782IDGKRG4	TPS60300DGSRG4	TS3USB30EDGSR
OPA209A1DGKR	SN74LVC1G27DCKRG4	TLV27L2CDGKR	TPS60300DGSR	TS5A1066DBVR
OPA2140A1DGKR	SN74LVC1G3208DBVR	TLV27L2CDGKRG4	TPS60300DGSRG4	TS5A1066DBVRE4
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OPA2209A1DGKT	SN74LVC1G38DBVRE4	TLV3402CDGKR	TPS60302DGS	TS5A22362DGSRG4
OPA2320A1DGKR	SN74LVC1G38DBVRG4	TLV3402CDGKRG4	TPS60302DGSRG4	TS5A22364DGSR
OPA2320A1DGKT	SN74LVC1G58DBVR	TLV3402IDGKR	TPS60303DGS	TS5A22364DGSRG4
OPA2322A1DGKR	SN74LVC1G58DBVRE4	TLV3402IDGKRG4	TPS60303DGSRG4	TS5A23157DGSR
OPA2322A1DGKT	SN74LVC1G58DBVRG4	TLV3702CDGKR	TPS60303DGSR	TS5A23157DGSR/2354
OPA2377A1DGKR	SN74LVC2G06DBVR	TLV3702CDGKRG4	TPS60303DGSRG4	TS5A23157DGSRE4
OPA2377A1DGKT	SN74LVC2G06DBVRE4	TLV3702IDGK	TPS60311DGSR	TS5A23157DGSRG4
OPA2379A1DCNRRG4	SN74LVC2G06DBVRG4	TLV3702IDGKRG4	TPS60311DGSRG4	TS5A23157DGST
OPA322A1DBVR	SN74LVC2G06DCKRG4	TLV4111IDGSR	TPS60312DGS	TS5A23157DGSTE4
OPA376A1DBVR	SN75HVD3082EDGKR	TLV4111IDGSRG4	TPS60312DGSR	TS5A23157DGSTG4

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OPA376A1DBVRG4	SN75HVD3082EDGKRG4	TLV4112IDGMR	TPS60312DGSRG4	TS5A23159DGSR
P82B96DGKR	SN761663DGKR	TLV4112IDGNRG4	TPS60313DGS	TS5A23159DGSRE4
P82B96DGKRG4	SN761663DGKRG4	TLV4113CDGQR	TPS60313DGSRG4	TS5A23159DGSRG4
PCA9515BDGKR	SN761666DGKR	TLV4113CDGQRG4	TPS60500DGS	TS5A23160DGSR
PCA9517DGKR	SN761666DGKRG4	TLV70012DDCR	TPS60500DGSRG4	TS5A23160DGSRE4
PCA9517DGKRG4	SNHVD3082EDGKG4	TLV70012DDCT	TPS60500DGSR	TS5A23160DGSRG4
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PCA9536DGKRG4	TCA4311ADGKR	TLV7211A1DCKR	TPS60501DGSR	TS5A3157DBVRE4
REF5010A1DGKR	TCA4311DGKR	TLV7211A1DCKRG4	TPS60501DGSRG4	TS5A3157DBVRG4
REF5010A1DGKT	TCA4311DGKRG4	TMP20A1DCKR	TPS60502DGS	TS5A3160DBVR
REF50101DGKR	THS3001IDGMR	TMP431CDGKR	TPS60502DGSRG4	TS5A3160DBVRE4
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REF5025A1DGKR	THS3111IDGMR	TMP431DDGKR	TPS60502DGSRG4	TS5A3160DCKJ
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REF50251DGKR	THS3120CDGMR	TMP432ADGSR	TPS61000DGSRG4	TS5A3160DCKRE4
REF50251DGKT	THS3120CDGNRG4	TMP432ADGST	TPS61002DGSR	TS5A3160DCKRG4
REF5030A1DGKR	THS3202DGN	TMP432BDGSR	TPS61002DGSRG4	TS5A3166DBVR
REF5030A1DGKT	THS3202DNG4	TMP432BDGST	TPS61004DGS	TS5A3166DBVRE4
REF50301DGKR	THS3202DGNR	TMP435ADGSR	TPS61004DGSRG4	TS5A3166DBVRG4
REF50301DGKT	THS3202DGNRG4	TMP435ADGST	TPS61005DGS	TS5A3167DBVR
REF5040A1DGKR	THS4011CDGN	TPA0211DGN	TPS61005DGSRG4	TS5A3167DBVRE4
REF5040A1DGKT	THS4011CDGNG4	TPA0211DGNRG4	TPS61005DGSR	TS5A3167DBVRG4
REF50401DGKR	THS4022IDGN	TPA0211DGNR	TPS61005DGSRG4	TS5A4594DBVR
REF50401DGKT	THS4022IDGNG4	TPA0211DGNRG4	TPS61006DGS	TS5A4594DBVRE4
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REF50451DGKR	THS4121CDGKR	TPA0223DGQR	TPS61007DGSRG4	TS5A4597DBVRE4
REF50451DGKT	THS4121CDGKRG4	TPA0223DGQRG4	TPS61010DGSR	TS5A4597DBVRG4
REF5050A1DGKR	THS4121IDGKR	TPA0233DGQR	TPS61010DGSRG4	TS5A4624DCKR
REF5050A1DGKT	THS4121IDGKRG4	TPA0233DGQRG4	TPS62000DGSR	TS5A4624DCKRE4
REF50501DGKR	THS4121IDGMR	TPA0253DGQ	TPS62000DGSRG4	TS5A4624DCKRG4
REF50501DGKT	THS4121IDGNRG4	TPA0253DGQG4	TPS62007DGS	TS5A4624DCKT
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SN1105002DCKR	THS4130CDGNRG4	TPA0253DGQRG4	TPS62007DGSR	TS5A4624DCKTG4
SN200602108DCKR	THS4140IDGN	TPA301DGN	TPS62007DGSRG4	TXB0101DBVR
SN200602108DCKRG4	THS4140IDGNG4	TPA301DGNRG4	TPS62051DGS	TXB0101DBVRG4
SN65EPT21DGKR	THS4151CDGK	TPA301DGNR	TPS62051DGSRG4	TXS0101DBVR
SN65EPT23DGKR	THS4151CDGKG4	TPA301DGNRG4	TPS62051DGSR	TXS0101DBVRG4
SN65HVD3082EDGK	THS4211DGK	TPA311DGN	TPS62051DGSRG4	

対象製品名 現行組立サイト: ASE-Shanghai				
BQ24202DGN	SN65HVD3088EDGKRG4	TLC0731DGQRG4	TPA301DGNR	TPS60311DGSR
BQ24202DNG4	SN65HVD485EDGKR	TLC081CDGMR	TPA301DGNRG4	TPS60311DGSRG4
DAC75541DGS	SN65HVD485EDGKRG4	TLC081CDGNRG4	TPA311DGN	TPS60312DGS
DAC75541DGSRG4	SN65LVDM176DGK	TLC081IDGMR	TPA311DNG4	TPS60312DGSR
DAC75541DGSR	SN65LVDM176DGKG4	TLC081IDGNRG4	TPA311DGNR	TPS60312DGSRG4
DAC75541DGSRG4	SN65LVDM176DGKR	TLC082IDGMR	TPA311DGNRG4	TPS60313DGS
DAC85511ADGKR	SN65LVDM176DGKRG4	TLC082IDGNRG4	TPA321DGNR	TPS60313DGSRG4
DAC85511ADGKRG4	SN65LVDS100DGK	TLC0831DGQ	TPA321DGNRG4	TPS60500DGS
DAC85511ADGKT	SN65LVDS100DGKG4	TLC0831DGQG4	TPA6100A2DGKR	TPS60500DGSRG4
DAC85511ADGKTG4	SN65LVDS100DGKR	TLV2242IDGK	TPA6100A2DGKRG4	TPS60500DGSR
DAC85511DGKR	SN65LVDS100DGKRG4	TLV2242IDGKG4	TPA6110A2DGNR	TPS60500DGSRG4
DAC85511DGKRG4	SN65LVDS179DGK	TLV2242IDGKR	TPA6110A2DGNRG4	TPS60501DGSR
DAC85511DGKT	SN65LVDS179DGKG4	TLV2242IDGKRG4	TPA701DGN	TPS60501DGSRG4
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DRV8830DGQR	SN65LVDS179DGKRG4	TLV2373IDGSRG4	TPA701DGNR	TPS60502DGS
DRV8832DGQR	SN65LVDS9637DGKR	TLV2402CDGK	TPA701DGNRG4	TPS60502DGS
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HPA00210DGS	SN65LVDS9638DGKR	TLV2402CDGKR	TPA711DGN	TPS61000DGS
HPA00231DDA	SN65LVDS9638DGKRG4	TLV2402CDGKRG4	TPA711DGNR	TPS61000DGS
HPA00231DDAR	SN65LVD100DGKR	TLV2402IDGKR	TPA711DGNRG4	TPS61002DGS
HPA00245DGS	SN65LVD100DGKRG4	TLV2402IDGKRG4	TPA721DGNR	TPS61002DGSRG4
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HPA00393DDAR	SN65LVEL11DGKR	TLV2452CDGKR	TPA731DGN	TPS61005DGS
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HPA00789DDAR	SN65LVEP11DGK	TLV2452IDGKR	TPA731DGNRG4	TPS61005DGS
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LMV342IDGKR	SN761663DGKR	TLV2453CDGSRG4	TPD4S009DGS	TPS61006DGS
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LPV358DGKR	SN761666DGKR	TLV2453IDGSRG4	TPS2376DDAR-HG4	TPS61007DGS
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OPA2140A1DGKR	THS3120CDGNR	TLV2473CDGQR	TPS3307-18DGNR	TPS62051DGS
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OPA2188A1DGKT	THS3202DGN	TLV2622IDGKR	TPS3617-50DGKR	TPS62052DGS
OPA2209A1DGKT	THS3202DNG4	TLV2622IDGKRG4	TPS3617-50DGKRG4	TPS62052DGSRG4
OPA2211A1DDA	THS3202DGNR	TLV272CDGKR	TPS3619-33DGKR	TPS62054DGS
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OPA2320A1DGKR	THS4011CDGN	TLV2762IDGKR	TPS3620-33DGKR	TPS62054DGS
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PCA9536DGKR	THS4500IDGKG4	TLV3702CDGKRG4	TPS5450DDA-P	TPS7A4901DGNR
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REF5010AIDGKT	THS4502CDGN	TLV4111IDGNR	TPS60200DGSR	TPS92510DGQR
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REF5010IDGKT	THS4502IDGN	TLV4112IDGNR	TPS60201DGS	TS3A24159DGSRG4
REF5025AIDGKR	THS4502IDGNG4	TLV4112IDGNRG4	TPS60201DGS64	TS3A4741DGKR
REF5025AIDGKT	THS4502IDGNR	TLV4113CDGQR	TPS60203DGS	TS3A4741DGKRG4
REF5025IDGKR	THS4502IDGNRG4	TLV4113CDGQRG4	TPS60203DGS64	TS3A4742DGKR
REF5025IDGKT	THS4503CDGNR	TMP431CDGKR	TPS60204DGS	TS3A4742DGKRG4
REF5030AIDGKR	THS4503CDGNRG4	TMP431CDGKT	TPS60204DGS64	TS3USB30EDGSR
REF5030AIDGKT	THS4503IDGNR	TMP431DDGKR	TPS60204DGSR	TS5A22362DGSR
REF5030IDGKR	THS4503IDGNRG4	TMP431DDGKT	TPS60204DGSRG4	TS5A22362DGSRG4
REF5030IDGKT	THS4505DGN	TMP432ADGSR	TPS60205DGSR	TS5A22364DGSR
REF5040AIDGKR	THS4505DGN4	TMP432ADGST	TPS60205DGSRG4	TS5A22364DGSRG4
REF5040AIDGKT	THS4505DGNR	TMP432BDGSR	TPS60210DGS	TS5A23157DGSR
REF5040IDGKR	THS4505DGNRG4	TMP432BDGST	TPS60210DGS64	TS5A23157DGSR/2354
REF5040IDGKT	THS4631DGN	TMP435ADGSR	TPS60210DGSR	TS5A23157DGSRE4
REF5045AIDGKR	THS4631DGN4	TMP435ADGST	TPS60210DGSRG4	TS5A23157DGSRG4
REF5045AIDGKT	THS4631DGNR	TPA0211DGN	TPS60211DGS	TS5A23157DGST
REF5045IDGKR	THS4631DGNRG4	TPA0211DGN4	TPS60211DGS64	TS5A23157DGSTE4
REF5045IDGKT	THS6072IDGNR	TPA0211DGNR	TPS60212DGSR	TS5A23157DGSTG4
REF5050AIDGKR	THS6072IDGNRG4	TPA0211DGNRG4	TPS60212DGSRG4	TS5A23159DGSR
REF5050AIDGKT	TL9600IDGKR-P	TPA0213DGQR	TPS60300DGS	TS5A23159DGSRE4
REF5050IDGKR	TL071IDGNR	TPA0213DGQRG4	TPS60300DGS64	TS5A23159DGSRG4
REF5050IDGKT	TL071IDGNRG4	TPA0223DGQR	TPS60300DGSR	TS5A23160DGSR
SN65EPT21DGKR	TL072CDGNR	TPA0223DGQRG4	TPS60300DGSRG4	TS5A23160DGSRE4
SN65EPT23DGKR	TL072CDGNRG4	TPA0233DGQR	TPS60301DGSR	TS5A23160DGSRG4
SN65HVD3082EDGK	TL072IDGN	TPA0233DGQRG4	TPS60301DGSRG4	UCC27200DDA
SN65HVD3082EDGKR	TL072IDGNG4	TPA0253DGQ	TPS60302DGS	UCC27200DDAG4
SN65HVD3085EDGKR	TL072IDGNR	TPA0253DGQG4	TPS60302DGS64	UCC27200DDAR
SN65HVD3085EDGKRG4	TL072IDGNRG4	TPA0253DGQR	TPS60303DGS	UCC27200DDARG4
SN65HVD3088EDGK	TL073CDGQ	TPA0253DGQRG4	TPS60303DGS64	UCC27201DDAR
SN65HVD3088EDGKG4	TL073CDGQG4	TPA301DGN	TPS60303DGSR	
SN65HVD3088EDGKR	TL073IDGQR	TPA301DGN4	TPS60303DGSRG4	

対象製品名 現行組立サイト: ASE-Weihai				
74AUC1G126DBVRE4	INA211AIDCKT	SN74AUP1G58DCKRG4	SN74LVC2G06DBVRE4	TPS79730DCKR
74AUC1G126DBVRG4	INA211AIDCKTG4	SN74AUP1G80DBVT	SN74LVC2G06DBVRG4	TPS79730DCKRG4
74AUC1G240DBVRE4	INA212AIDCKT	SN74AUP1G80DBVTE4	SN74LVC2G06DCKRG4	TPS79733DCKR
74AUC1G240DBVRG4	INA212AIDCKTG4	SN74AUP1G80DBVTG4	TLV70220PDBVR	TPS79733DCKRG4
74AVCH1T45DBVRE4	INA213AIDCKR	SN74AUP1G97DBVR	TLV7211AIDCKR	TS12A4516DBVR
74AVCH1T45DBVRG4	INA213AIDCKRG4	SN74AUP1G97DBVRE4	TLV7211AIDCKRG4	TS12A4517DBVR
74AVCH1T45DBVTE4	INA214AIDCKR	SN74AUP1G97DBVRG4	TMP20AIDCKR	TS321IDBVR
74AVCH1T45DBVTG4	INA214AIDCKRG4	SN74AUP1T57DBVR	TPD2E009DBZR	TS321IDBVRE4
74AVCH1T45DCKRG4	LMV981IDCKRG4	SN74AUP1T57DBVRE4	TPD4S009DCKR	TS321IDBVRG4
74AVCH1T45DCKTG4	OPA140AIDBVR	SN74AUP1T57DBVRG4	TPD4S009DCKRG4	TS5A1066DBVR
74CB3T1G125DBVRE4	OPA140AIDBVT	SN74AUP1T57DCKRG4	TPL0401A-10DCKR	TS5A1066DBVRE4
74CB3T1G125DBVRG4	OPA171AIDBVT	SN74AUP1T58DCKRG4	TPL0401B-10DCKR	TS5A1066DBVRG4
74CBT1G125DBVRE4	OPA322AIDBVR	SN74AUP1T97DBVT	TPS3800G27DCKR	TS5A3157DBVR
74CBT1G125DBVRG4	OPA376AIDBVR	SN74AUP1T97DBVTE4	TPS3800G27DCKRG4	TS5A3157DBVRE4
74CBT1G384DBVRE4	OPA376AIDBVRG4	SN74AUP1T97DBVTG4	TPS3801-01DCKR	TS5A3157DBVRG4
74CBT1G384DBVRG4	SN0710019DCKR	SN74AUP1T97DCKRG4	TPS3801-01DCKRG4	TS5A3160DBVR
74CBTD1G125DBVRE4	SN1105002DCKR	SN74AVC1T45DBVR	TPS3801E18DCKR	TS5A3160DBVRE4
74CBTD1G125DBVRG4	SN200602108DCKR	SN74AVC1T45DBVRE4	TPS3801E18DCKRG4	TS5A3160DBVRG4
74CBTD1G384DBVRE4	SN200602108DCKRG4	SN74AVC1T45DBVRG4	TPS3801K33DCKR	TS5A3160DCKJ
74CBTD1G384DBVRG4	SN74AUC1G00DBVR	SN74AVC1T45DCKRG4	TPS3801K33DCKRG4	TS5A3160DCKR

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74LVC1G132DBVRE4	SN74AUC1G00DBVRE4	SN74AVCH1T45DBVR	TPS3801T50DCKR	TS5A3160DCKRE4
74LVC1G132DBVRG4	SN74AUC1G00DBVRG4	SN74AVCH1T45DBVT	TPS3801T50DCKRG4	TS5A3160DCKRG4
74LVC1G132DCKRG4	SN74AUC1G02DCKR	SN74CB3T1G125DBVR	TPS3802K33DCKR	TS5A3166DBVR
74LVC1G3208DBVRG4	SN74AUC1G02DCKRE4	SN74CBT1G125DBVR	TPS3802K33DCKRG4	TS5A3166DBVRE4
74LVC1G373DBVRE4	SN74AUC1G02DCKRG4	SN74CBT1G384DBVR	TPS3802L30DCKR	TS5A3166DBVRG4
74LVC1GX04DCKRG4	SN74AUC1G07DBVR	SN74CBTD1G125DBVR	TPS3802L30DCKRG4	TS5A3167DBVR
HPA00328DCKR	SN74AUC1G07DBVRE4	SN74CBTD1G384DBVR	TPS3803-01DCKR	TS5A3167DBVRE4
HPA00366DCKR	SN74AUC1G07DBVRG4	SN74LVC1G0832DBVR	TPS3803-01DCKRG4	TS5A3167DBVRG4
HPA00422DCKR	SN74AUC1G126DBVR	SN74LVC1G132DBVR	TPS3805H33DCKR	TS5A4594DBVR
HPA00423DCKR	SN74AUC1G14DBVR	SN74LVC1G132DBVT	TPS3805H33DCKRG4	TS5A4594DBVRE4
HPA00456DCKR	SN74AUC1G14DBVRE4	SN74LVC1G132DBVTE4	TPS71501DCKR	TS5A4594DBVRG4
HPA00528DCKR	SN74AUC1G14DBVRG4	SN74LVC1G132DBVTG4	TPS71501DCKR/2801	TS5A4597DBVR
HPA00579DCKR	SN74AUC1G240DBVR	SN74LVC1G132DCKR	TPS71501DCKRG4	TS5A4597DBVRE4
HPA00653DCKR	SN74AUC1G32DBVR	SN74LVC1G18DBVR	TPS71523DCKR	TS5A4597DBVRG4
HPA00681DCKR	SN74AUC1G32DBVRE4	SN74LVC1G18DBVRE4	TPS71523DCKRG4	TS5A4624DCKR
HPA00683DCKR	SN74AUC1G32DBVRG4	SN74LVC1G18DBVRG4	TPS71525DCKR	TS5A4624DCKRE4
HPA00763DCKR	SN74AUC2G04DCKRG4	SN74LVC1G27DCKRG4	TPS71525DCKRG4	TS5A4624DCKRG4
HPA01091DBVR	SN74AUC2G07DBVR	SN74LVC1G3208DBVR	TPS71530DCKR	TS5A4624DCKT
INA199A1DCKR	SN74AUC2G07DBVRE4	SN74LVC1G373DBVR	TPS71530DCKRG4	TS5A4624DCKTE4
INA199A2DCKR	SN74AUC2G07DBVRG4	SN74LVC1G38DBVR	TPS71533DCKR	TS5A4624DCKTG4
INA199A2DCKT	SN74AUP1G07DBVR	SN74LVC1G38DBVRE4	TPS71533DCKRG4	TXB0101DBVR
INA199A3DCKR	SN74AUP1G07DBVRE4	SN74LVC1G38DBVRG4	TPS71550DCKR	TXB0101DBVRG4
INA210A1DCKR	SN74AUP1G07DBVRG4	SN74LVC1G58DBVR	TPS71550DCKR/2801	TXS0101DBVR
INA210A1DCKRG4	SN74AUP1G08DBVR	SN74LVC1G58DBVRE4	TPS71550DCKRG4	TXS0101DBVRG4
INA211A1DCKR	SN74AUP1G08DBVRE4	SN74LVC1G58DBVRG4	TPS79718DCKR	
INA211A1DCKRG4	SN74AUP1G08DBVRG4	SN74LVC2G06DBVR	TPS79718DCKRG4	

製品表示

今回の変更に伴い、出荷ラベルに記載の原産地(ラベル箇所:22L)及び製品捺印が下記のようになります。

	組立サイト	組立サイトコード(22L)
現行	Hana-Thai	ASO: HNT
追加認定	UTAC2	ASO: NS2
	NFME	ASO: NFM
	ASE-Shanghai	ASO: ASH
	ASE-Weihai	ASO: AWH



図1 出荷ラベルの例

信頼性試験

Reference Qual #1

信頼性試験結果				
信頼性試験期間	開始	—	終了	2011 年 8 月 8 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS73201QDBVRQ1	-	-	
Assembly Site:	NFME	Package/Code/Pins:	SOT/DBV/5	
Mount Compound:	A-03	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**HTOL	125C/1000hrs, 150C/408hrs	77/0	77/0	77/0
**HAST	85C/85%, 1000 hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Surface Mount Solderability	Pb Solder	22/0	-	-
Physical Dimensions	per mechanical drawing	10/0	10/0	10/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	-	-
Note: ** Preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 9 月 17 日
信頼性試験 - 試料構成詳細				
ID:	Device1	Device2		
Qual Device:	TPS2065DBV	TPS61041DBV		
Assembly Site:	NFME	NFME		
Package/Code/Pins:	SOT/DBV/5	SOT/DBV/5		
Mount Compound:	A-03	A-03		
Mold Compound:	R-13	R-13		
Bond Wire:	0.8 mil Dia., Au	0.8 Mil Dia., Au		
Leadframe (Finish, Base):	NiPdAu, Cu	NiPdAu, Cu		
MSL:	JEDEC L-1/260C	JEDEC L-1/260C		
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device1	Device2	
Electrical Characterization	Full Temp & Voltage range	Approved	Approved	
**Autoclave	121C, 96 Hrs	77/0	77/0	
**T/C	-65C/150C, 500 Cyc	87/0	86/0	
Surface Mount Solderability	8 Hrs Steam	22/0	22/0	
Bond Pull	76 ball bonds, min. 3 units	5/0	5/0	
Moisture Sensitivity	JEDEC L-1/260C	22/0	22/0	
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	
Note: ** Preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 3 月 30 日
信頼性試験 — 試料構成詳細				
Qual Device:	OPA365AIDBV	-	-	
Assembly Site:	NFME	Package/Code/Pins:	SOT/DBV/5	
Mount Compound:	A-03	Mold Compound:	R-13	
Bond Wire:	1.0 Mil Dia., Au	Leadframe (Finish, Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
**High Temp. Storage Bake	170C, 420 Hours		77/0	
**Autoclave	121C, 96 Hrs		77/0	
**T/C	-65C/150C, 500 Cyc		80/0	
Visual / Mechanical	Performed during Assembly MQ		Approved	
Surface Mount Solderability	Pb Solder		22/0	
Lead Fatigue	22 leads, min. 3 units		22/0	
Lead Pull	22 leads to destruction, min. 3 units		22/0	
Lead Finish Adhesion	-		15/0	
Physical Dimensions	per mechanical drawing		5/0	
Ball Bond Shear	Wires		78/0	
Bond Pull	Wires		78/0	
Die Shear	-		10/0	
Manufacturability (Assembly)	per mfg. Site specification		Approved	
**Thermal Shock	-65C/150C, 500 Cyc		77/0	
Salt Atmosphere	24 Hrs		22/0	
X-ray	top side only		5/0	
Moisture Sensitivity	JEDEC L-1/260C		12/0	
Note: ** Preconditioning sequence: JEDEC L-1/260C				

Reference Qual #2

信頼性試験結果				
信頼性試験期間	開始	—	終了	2011 年 7 月 18 日
信頼性試験 - 試料構成詳細				
ID:	Device1	Device2	Device3	
Qual Device:	OPA330AIDCK	TMP330AIDCK	TPS71719DCK	
Assembly Site:	NFME	NFME	NFME	
Package/Code/Pins:	SOT/DCK/5	SOT/DCK/6	SOT/DCK/5	
Mount Compound:	A-03	A-03	A-03	
Mold Compound:	R-07	R-07	R-07	
Bond Wire:	1.0 Mil Dia., Au	1.0 Mil Dia., Au	1.0 Mil Dia., Au	
Leadframe (Finish, Base):	NiPdAu, Cu	NiPdAu, Cu	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	JEDEC L-1/260C	JEDEC L-1/260C	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device1	Device2	Device3
**High Temp. Storage Bake	170C, 420hrs	77/0	77/0	-
Electrical Characterization	Over Temp	-	-	Approved
**Unbiased HAST	130C/85%RH, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Solderability	Steam age, 8 hours	22/0	22/0	-
Lead Pull	# of leads to destruction, min. 3 units	22/0	22/0	22/0
Lead Fatigue	# of leads, min. 3 units	22/0	22/0	22/0
Lead Finish Adhesion	# of leads, min. 3 units	15/0	15/0	15/0
Manufacturability	per mfg. Site specification	Approved	Approved	Approved
X-ray	top side only	5/0	5/0	-
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Notes: ** Preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2006 年 10 月 4 日
信頼性試験 - 試料構成詳細				
Qual Device:	LPV321DCKR	-	-	
Assembly Site:	NFME	Package Code/Pins:	DCK/5	
Mount Compound:	A-03	Mold Compound:	R-07	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAu, Cu	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 hours	40/0	40/0	40/0
**Biased HAST	130C/85%RH, 96 hours	26/0	26/0	26/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**Temperature Cycle	-65C/150C, 500 Cyc	77/0	77/0	77/0
**Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
**Storage Bake	170C, 1000 hours	77/0	77/0	77/0
Lead Pull	-	22/0	22/0	22/0
Flammability	UL 94V-0	5/0	5/0	5/0
Flammability	UL-1694	5/0	5/0	5/0
Flammability	IEC 695-2-2	5/0	5/0	5/0
X-RAY	top side only	5/0	5/0	5/0
Visual / Mechanical	-	Approved	Approved	Approved
Moisture Sensitivity	JEDEC L-1/260C	7/0	8/0	8/0
Note: ** Preconditioning sequence JEDEC L-1/260C				

Reference Qual #3

信頼性試験結果				
信頼性試験期間	開始	—	終了	2007 年 1 月 30 日
信頼性試験 - 試料構成詳細				
Qual Device:	LM317DCY	-	-	
Assembly Site:	NFME	Package/Code/Pins:	SOT/DCY/4	
Mount Compound:	A-06	Mold Compound:	R-07	
Bond Wire:	2.0 mil Dia., Au	Leadframe (Finish, Base):	Matte Sn, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
** High Temp Operating Life	150C, 300 hours	40/0	40/0	40/0
** Biased HAST	130C/85%RH, 96 hours	26/0	26/0	26/0
** Autoclave	121C, 96 Hrs	77/0	77/0	77/0
** Temp Cycle	-65C/150C, 500 Cyc	77/0	77/0	77/0
** Storage Bake	150C, 1000 hours	77/0	77/0	77/0
Solderability	8 Hours Steam Age	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Lead Pull	-	22/0	22/0	22/0
Lead Integrity	-	22/0	22/0	22/0
Flammability	UL 94V-0	5/0	5/0	5/0
Flammability	UL-1694	5/0	5/0	5/0
Flammability	IEC 695-2-2	5/0	5/0	5/0
X-RAY	-	5/0	5/0	5/0
Physical Dimensions	-	5/0	5/0	5/0
Ball Bond Shear	-	78/0	78/0	78/0
Wire Pull	-	78/0	78/0	78/0
Die Shear	-	10/0	10/0	10/0
Salt Atmosphere	-	22/0	22/0	22/0
Moisture Sensitivity	JEDEC L-2/260C	12/0	12/0	12/0
Manufacturability	-	Approved	Approved	Approved
Note: ** Preconditioning Sequence: JEDEC L-2/260C				

Reference Qual #4

信頼性試験結果				
信頼性試験期間	開始	—	終了	2011 年 7 月 18 日
信頼性試験 - 試料構成詳細				
Qual Device:	TLV70228DBV	-	-	
Assembly Site:	NS2	Package/Code/Pins:	SOT/DBV/5	
Mount Compound:	PZ0001	Mold Compound:	R-13	
Leadframe (Finish,Base):	NiPdAu, Cu	MSL:	JEDEC L-1/260C	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
HTOL High Temp. Op Life	140C, 48, 324 Hrs	116/0	116/0	116/0
Electrical Characterization	-	30/0	30/0	30/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
ESD CDM	500V	3/0	3/0	3/0
Process Characterization	BG, Die-saw & Die attach	Approved	Approved	Approved
Visual / Mechanical	Post Die-saw	328/0	328/0	328/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
Destructive Physical Analysis	Pre-stress	2/0	2/0	2/0
Manufacturability	per mfg. Site specification	Approved	Approved	Approved
X-ray	top side only	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Note: ** Preconditioning sequence: JEDEC L-1/260C				

Reference Qual #5

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 5 月 20 日
信頼性試験 - 試料構成詳細				
Qual Device:	OPA379AIDCK	-	-	
Assembly Site:	NSE	Package/Code/Pins:	SOT/DCK/5	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
** Autoclave	121C, 96 Hrs		77/0	
** Temp Cycle	-65C/150C, 500 cycles		77/0	
Visual/Mechanical	Per final visual inspection criteria		Approved	
Bond Strength	76 ball bonds, min. 3 units		76/0	
Die Shear	-		10/0	
Manufacturability	per mfg. Site specification		Approved	
X-Ray	Top Side Only		5/0	
Moisture Sensitivity	JEDEC L-2/260C		10/0	
Note: ** Preconditioning Sequence: JEDEC L-2/260C				

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信頼性試験結果				
信頼性試験期間	開始	—	終了	2004 年 8 月 10 日
信頼性試験 - 試料構成詳細				
Qual Device:	TS5A3159IM	-	-	
Assembly Site:	NSE	Package/Code/Pins:	SOT/DCK/6	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 hours	40/0	40/0	40/0
**Biased HAST	130C/85%RH, 300 hours	26/0	26/0	26/0
** Autoclave	121C, 96 Hrs	77/0	77/0	77/0
** Temp Cycle	-65C/150C, 500 cycles	77/0	77/0	77/0
**Thermal Shock	-65C/150C, 500 cycles	77/0	77/0	77/0
**Storage Bake	17C, 420 hours	77/0	77/0	77/0
Solderability	-	22/0	22/0	22/0
Lead Pull	-	22/0	22/0	22/0
Lead Integrity	-	22/0	22/0	22/0
X-Ray	Top Side Only	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	-	-
Note: ** Preconditioning Sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2006 年 6 月 22 日
信頼性試験 - 試料構成詳細				
Qual Device:	SN200604024DCK	-	-	
Assembly Site:	NSE	Package/Code/Pins:	SOT/DCK/6	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 hours	116/0	-	-
Electrical Characterization	-	Approved	-	-
** Autoclave	121C, 96 Hrs	77/0	77/0	77/0
** Temp Cycle	-65C/150C, 500 cycles	77/0	77/0	77/0
ESD HBM	2000V	3/0	-	-
ESD CDM	500V	3/0	-	-
Latch-up	per JEESD78	6/0	-	-
Manufacturability	per mfg. Site specification	Approved	-	-
X-Ray	Top Side Only	5/0	-	-
Moisture Sensitivity	JEDEC L-1/260C	12/0	-	-
Note: ** Preconditioning Sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 5 月 2 日
信頼性試験 - 試料構成詳細				
Qual Device:	TL4050C10IDCKR	-	-	
Assembly Site:	NS2	Package/Code/Pins:	SOT/DCK/5	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
** Autoclave	121C, 96 Hrs	77/0	77/0	77/0
** Temp Cycle	-65C/150C, 500 cycles	77/0	77/0	77/0
Physical Dimensions	per mechanical drawing	5/0	5/0	5/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
Manufacturability	per mfg. Site specification	Approved	Approved	Approved
X-Ray	Top Side Only	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Note: ** Preconditioning Sequence: JEDEC L-1/260C				

Reference Qual #6

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 5 月 20 日
信頼性試験 - 試料構成詳細				
Qual Device:	REF3112AIDBZ	-	-	
Assembly Site:	NS2	Package/Code/Pins:	SOT/DBZ/3	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
** Autoclave	121C, 96 Hrs		77/0	
** Temp Cycle	-65C/150C, 500 cycles		77/0	
Visual/Mechanical	Per final visual inspection criteria		Approved	
Bond Strength	76 ball bonds, min. 3 units		76/0	
Die Shear	-		10/0	
Manufacturability	per mfg. Site specification		Approved	
X-Ray	Top Side Only		5/0	
Moisture Sensitivity	JEDEC L-2/260C		10/0	
Note: ** Preconditioning Sequence: JEDEC L-2/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2004 年 8 月 10 日
信頼性試験 - 試料構成詳細				
Qual Device:	TS5A3159IM	-	-	
Assembly Site:	NSE	Package/Code/Pins:	SOT/DBZ/6	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
** Autoclave	121C, 96 Hrs		77/0	
** Temp Cycle	-65C/150C, 500 cycles		77/0	
Visual/Mechanical	Per final visual inspection criteria		Approved	
Bond Strength	76 ball bonds, min. 3 units		76/0	
Die Shear	-		10/0	
Manufacturability	per mfg. Site specification		Approved	
X-Ray	Top Side Only		5/0	
Moisture Sensitivity	JEDEC L-1/260C		10/0	
Note: ** Preconditioning Sequence: JEDEC L-1/260C				

Reference Qual #7

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 8 月 13 日
信頼性試験 - 試料構成詳細				
Qual Device:	INA219AIDCN	-	-	
Assembly Site:	NSE	Package/Code/Pins:	SOT23/DCN/8	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
**Life Test	150C, 300 Hrs		116/0	
Electrical Characterization	-		Approved	
**Biased HAST	130C/85%RH, 96 Hrs		77/0	
** Autoclave	121C, 96 Hrs		77/0	
** Temp Cycle	-65C/150C, 1000 cycles		77/0	
ESD HBM	2000V		3/0	
ESD CDM	500V		3/0	
Thermal Impedance	-		5/0	
Electro-migration	-		Approved	
Hot Electron Injection	-		Approved	
Latch-up	per JESD78		6/0	
Manufacturability	per mfg. Site specification		Approved	
X-Ray	Top Side Only		5/0	
Moisture Sensitivity	JEDEC L-2/260C		10/0	
Note: ** Preconditioning Sequence: JEDEC L-2/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2007 年 7 月 12 日
信頼性試験 — 試料構成詳細				
Qual Device:	TMP421AIDCN	-	-	
Assembly Site:	NSE	Package/Code/Pins:	SSOP/DCN/8	
Mount Compound:	A-09	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test		Condition / Duration		Sample Size/ Fails
** Autoclave		121C, 240 hours		79/0
** Temp Cycle		-65C/150C, 1000 cycles		80/0
ESD CDM		500V		3/0
X-Ray		Top Side Only		5/0
Note: ** Preconditioning Sequence: JEDEC L-2/260C				

Reference Qual #8

信頼性試験結果

信頼性試験期間	開始	—	終了	2011 年 10 月 18 日
信頼性試験 — 試料構成詳細				
Qual Device:	TPS781250200DDC	-	-	
Assembly Site:	NS2 (UTAC2)	Package/Code/Pins:	TSOT-23/DDC/5	
Mount Compound:	PZ0013	Mold Compound:	R-13	
Bond Wire:	1.3 mil Dia., Au	Leadframe (Finish, Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
** High Temp Operating Life	150C, 300 Hrs		116/0	
Electrical Characterization	-		30/0	
**Autoclave	121C, 96 Hrs		77/0	
**T/C	-65C/150C, 500 Cyc		77/0	
ESD HBM	2000V		3/0	
ESD CDM	500V		3/0	
Latchup	-		6/0	
Manufacturability (Assembly)	per mfg. Site specification		Approved	
Moisture Sensitivity	JEDEC L-2/260C		12/0	
FTY and Bin Summary	-		Approved	
Notes: ** Tests require preconditioning sequence: JEDEC L-2/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 3 月 24 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS78001DDC	-	-	
Assembly Site:	UTAC/NSE	Package/Code/Pins:	SOT/DDC/5	
Mount Compound:	PZ0013	Mold Compound:	R-13	
Bond Wire:	1.3 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 Hrs	116/0	-	-
Electrical Char.	-	15/0	-	-
**Biased HAST	130C/85%RH, 96, 192 Hrs	77/0	-	-
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
ESD HBM	2000V	3/0	-	-
ESD CDM	500V	3/0	-	-
Latch-up	per JEDEC78	6/0	-	-
Manufacturability	per mfg. Site specification	Approved	-	-
Moisture Sensitivity	JEDEC L-2/260C	12/0	-	-
Note: ** Preconditioning sequence JEDEC L-2/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 3 月 24 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS780330220DDC	-	-	
Assembly Site:	UTAC/NSE	Package/Code/Pins:	SOT/DDC/5	
Mount Compound:	PZ0013	Mold Compound:	R-13	
Bond Wire:	1.3 mil Dia., Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 Hrs	116/0	-	-
Electrical Characterization	Full Temperature	15/0	-	-
**Biased HAST	130C/85%RH, 96 Hrs	77/0	-	-
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	-	-
ESD HBM	2000V	3/0	-	-
ESD CDM	500V	3/0	-	-
Latch-up	per JEDEC78	6/0	-	-
Manufacturability	per mfg. Site specification	Approved	-	-
Moisture Sensitivity	JEDEC L-2/260C	12/0	-	-
Note: ** Preconditioning sequence JEDEC L-2/260C				

Reference Qual #9

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 1 月 22 日
信頼性試験 - 試料構成詳細				
Qual Device:	SN74LVC1G14DBVR	-	-	
Assembly Site:	ASEWH	Package/Code/Pins:	SOT/DBV/5	
Mount Compound:	1120999A1	Mold Compound:	R-13	
Bond Wire:	0.8 mil Dia. Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
Electrical Char.	-	Approved	Approved	Approved
High Temp. Storage Bake	170C, 420 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
X-Ray	-	5/0	5/0	5/0
Moisture Sensitivity	-	12/0	12/0	12/0
Note: ** must be preconditioned per the appropriate sequence, JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010年1月22日
信頼性試験 - 試料構成詳細				
Qual Device:	TL431CDBVR	-	-	
Assembly Site:	ASEWH	Package/Code/Pins:	SOT/DBV/5	
Mount Compound:	1120999A1	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia. Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 Hrs	77/0	77/0	77/0
Electrical Char.	-	Approved	Approved	Approved
**High Temp. Storage Bake	150C, 500 Hrs	77/0	77/0	77/0
**Biased HAST	130C/85%RH, 96 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Solderability	Steam age, 8 hours	22/0	22/0	22/0
Lead Pull	-	22/0	22/0	22/0
Lead Fatigue	-	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Physical Dimensions	-	5/0	5/0	5/0
Flammability	-	5/0	5/0	5/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
X-Ray	-	5/0	5/0	5/0
Moisture Sensitivity	-	12/0	12/0	12/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
Note: ** must be preconditioned per appropriate sequence JEDEC L-1/260C				

Reference Qual #10

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010年1月22日
信頼性試験 - 試料構成詳細				
Qual Device:	LMV721IDCKR	-	-	
Assembly Site:	ASEWH	Package/Code/Pins:	SC70/DCK/5	
Mount Compound:	1120999A1	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia. Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	150C, 300 Hrs	77/0	77/0	77/0
**Biased HAST	130C/85%RH, 96 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
**Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
High Temp. Storage Bake	150C, 500 Hrs	77/0	77/0	77/0
Solderability	Steam age, 8 hours	22/0	22/0	22/0
Flammability	Method A – UL 94-0	5/0	5/0	5/0
Flammability	Method B – IEC 695-2-2	5/0	5/0	5/0
Flammability	Method C – UL 1694	5/0	5/0	5/0
Lead Pull	# of leads to destruction, min. 3 Units	22/0	22/0	22/0
Lead Fatigue	# of leads, min. 3 Units	22/0	22/0	22/0
Lead Finish Adhesion	# of leads, min. 3 Units	15/0	15/0	15/0
Physical Dimensions	-	5/0	5/0	5/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
X-Ray	-	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Electrical Characterization	-	Approved	Approved	Approved
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
Notes: ** Tests require preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 1 月 22 日
信頼性試験 - 試料構成詳細				
Qual Device:	SN74LVC2G14DCKR	-	-	
Assembly Site:	ASEWH	Package/Code/Pins:	SC70/DCK/6	
Mount Compound:	1120999A1	Mold Compound:	R-13	
Bond Wire:	0.8 mil Dia. Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
Electrical Characterization	-	Approved	Approved	Approved
**High Temp. Storage Bake	150C, 1000 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
**Thermal Shock	-65C/150C, 1000 Cyc	77/0	77/0	77/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
X-Ray	-	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	-	-
Notes: ** Tests require preconditioning sequence: JEDEC L-1/260C				

Reference Qual #11

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 1 月 22 日
信頼性試験 - 試料構成詳細				
Qual Device:	TLV431BIDBZR	-	-	
Assembly Site:	ASEWH	Package/Code/Pins:	SOT/DBZ/3	
Mount Compound:	1120999A1	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia. Au	Leadframe (Finish,Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**Life Test	150C, 300 Hrs	77/0	77/0	77/0
Electrical Char.	-	Approved	Approved	Approved
**High Temp. Storage Bake	170C, 420 Hrs	77/0	77/0	77/0
**Biased HAST	130C/85%RH, 96 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Solderability	Steam age, 8 hours	22/0	22/0	22/0
Lead Pull	-	22/0	22/0	22/0
Lead Fatigue	-	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Physical Dimensions	-	5/0	5/0	5/0
Flammability	-	5/0	5/0	5/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
X-Ray	-	5/0	5/0	5/0
Moisture Sensitivity	-	12/0	12/0	12/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
Note: ** must be preconditioned per the appropriate sequence, JEDEC L-1/260C				

Reference Qual #12

信頼性試験結果				
信頼性試験期間	開始	—	終了	2008 年 5 月 30 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS40003DGQ	-	-	
Assembly Site:	NS2	Package/Code/Pins:	VSSOP/DGQ/10	
Mount Compound:	PZ0013	Mold Compound:	R-13	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAu, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**Autoclave	121C, 96 Hrs	76/0	76/0	76/0
**T/C	-65C/150C, 250, 500 Cyc	76/0	76/0	76/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Die Shear	-	10/0	10/0	10/0
Manufacturability	per mfg. Site specification	Approved	Approved	Approved
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Notes: ** Tests require preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2005 年 6 月 7 日
信頼性試験 - 試料構成詳細				
ID:	Device1		Device2	
Qual Device:	UC2903N		UCC2801D	
Assembly Site:	NSE		NSE	
Package/Code/Pins:	PDIP/N/18		SOIC/D/8	
Mount Compound:	PZ0013		PZ0013	
Mold Compound:	R-13		R-13	
Leadframe finish:	NiPdAu		NiPdAu	
ID:	Device3		Device4	
Qual Device:	OPO7CD		SN0305028AIDBV	
Assembly Site:	NSE		NSE	
Package/Code/Pins:	SOIC/D/8		SOT/DBV/6	
Mount Compound:	PZ0001		PZ0001	
Mold Compound:	R-13		R-13	
Leadframe finish:	NiPdAu		NiPdAu	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device1	Device2	
Life Test	125C, 1000Hrs.	348/0	-	
HAST	130C/85%RH, 96 Hrs.	231/0	-	
Autoclave	121C, 240 Hrs.	231/0	-	
Thermal Shock	-65C/150C, 1000 cycles	-	-	
Temp Cycle	-65C/150C, 1000 cycles	231/0	231/0	
High-Temp Storage	150C, 1000Hrs.	135/0	-	
X-Ray	Top side	Approved	Approved	
Lead Fatigue	-	Approved	-	
Solderability	8 hr steam age/flux/Dip	Approved	-	
Physical Dimensions	Per mechanical drawing	Approved	-	
Visual/Mechanical	-	Approved	Approved	
Salt Atmosphere	24 Hrs.	Approved	-	
Manufacturability (MQ)	Assembly Site	-	Approved	
Moisture Sensitivity	JEDEC L-1/260C	-	Approved	
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device3	Device4	
Life Test	125C, 1000Hrs.	103/0	116/0	
HAST	130C/85%RH, 96 Hrs.	231/0	98/0	
Autoclave	121C, 240 Hrs.	231/0	80/0	
Thermal Shock	-65C/150C, 1000 cycles	231/0	119/0	
Temp Cycle	-65C/150C, 1000 cycles	Note(1)	80/0	
High-Temp Storage	170C,420 Hrs.	135/0	-	
High-Temp Storage	150C, 1000Hrs.	-	49/0	
X-Ray	Top side	Approved	Approved	
Lead Fatigue	-	Approved	-	
Solvent Resistance	-	Note(1)	Note(1)	
Solderability	8 hr steam age/flux/Dip	Approved	Note(1)	
Physical Dimensions	Per mechanical drawing	Approved	Note(1)	
Flammability	UL94 Class V-0	Approved	Note(1)	
Visual/Mechanical	-	Approved	Note(1)	
Salt Atmosphere	24 Hrs.	Approved	Note(1)	
Manufacturability (MQ)	Assembly Site	Approved	Approved	
Moisture Sensitivity	JEDEC L-1/260C	Approved	Approved*	
Notes:				
* This device was previously classified at JEDEC L-2/260C.Subsequent testing has shown that this device is now classified at JEDEC L-1/260C.				
(1) NSE package qual data has been utilized				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2005 年 6 月 7 日
信頼性試験 - 試料構成詳細				
ID:	Device5	Device6	Device7	
Qual Device:	OPA690N/SN030711DBV	TPS62202DBV	OPA695IDBV	
Assembly Site:	NSE	NSE	NSE	
Package/Code/Pins:	SOT/DBV/6	SOT/DBV/5	SOT/DBV/6	
Mount Compound:	PZ0001	PZ0001	PZ0001	
Mold Compound:	R-13	R-13	R-13	
Leadframe finish:	NiPdAu	NiPdAu	NiPdAu	
ID:	Device8	Device9	-	
Qual Device:	TMP101NA	TLV2361CDBV	-	
Assembly Site:	NSE	NSE	-	
Package/Code/Pins:	SOT/DBV/6	SOT/DBV/5	-	
Mount Compound:	PZ0001	PZ0001	-	
Mold Compound:	R-13	R-13	-	
Leadframe finish:	NiPdAu	NiPdAu	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device5	Device6	Device7
Life Test	125C, 1059Hrs.	-	-	118/0
	125C, 1000Hrs.	120/0	Note(1)	-
HAST	130C/85%RH, 96 Hrs.	98/0	Note(1)	97/0
Autoclave	121C, 240 Hrs.	98/0	154/0	98/0
Thermal Shock	-65C/150C, 1000 cycles	Note(1)	154/0	Note(1)
Temp Cycle	-65C/150C, 1000 cycles	98/0	154/0	98/0
High-Temp Storage	170C, 420 Hrs.	-	Note(1)	-
	150C, 1000Hrs.	49/0	-	49/0
X-Ray	Top side	Approved	Note(1)	Approved
Solvent Resistance	-	Note(1)	Note(1)	Note(1)
Solderability	8 hr steam age/flux/Dip	Note(1)	Note(1)	Note(1)
Physical Dimensions	Per mechanical drawing	Note(1)	Note(1)	Note(1)
Flammability	UL94 Class V-0	Note(1)	Note(1)	Note(1)
Visual/Mechanical	-	Note(1)	Note(1)	Note(1)
Salt Atmosphere	24 Hrs.	Note(1)	Note(1)	Note(1)
Manufacturability (MQ)	Assembly Site	Approved	Approved	Approved
Moisture Sensitivity	JEDEC L-1/260C	Approved*	Approved	Approved*
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device8	Device9	-
Life Test	150C, 300Hrs.	116/0	-	-
	150C, 500 Hrs	-	120/0	-
HAST	130C/85%RH, 96 Hrs.	80/0	78/0	-
Autoclave	121C, 96 Hrs.	-	231/0	-
	121C, 240 Hrs.	80/0	-	-
Thermal Shock	-65C/150C, 1000 cycles	Note(1)	231/0	-
Temp Cycle	-65C/150C, 1000 cycles	79/0	-	-
High-Temp Storage	170C, 420 Hrs.	Note(1)	135/0	-
X-Ray	Top side	Note(1)	Approved	-
Solvent Resistance	-	Note(1)	-	-
Solderability	8 hr steam age/flux/Dip	Note(1)	Approved	-
Physical Dimensions	Per mechanical drawing	Note(1)	Approved	-
Flammability	UL94 Class V-0	Approved	Approved	-
Visual/Mechanical	-	Note(1)	-	-
Salt Atmosphere	24 Hrs.	Note(1)	Approved	-
Manufacturability (MQ)	Assembly Site	Approved	Approved	-
Moisture Sensitivity	JEDEC L-1/260C	Approved*	Approved	-
Notes:				
* This device was previously classified at JEDEC L-2/260C. Subsequent testing has shown that this device is now classified at JEDEC L-1/260C.				
(1) NSE package qual data has been utilized				

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信頼性試験結果				
信頼性試験期間	開始	—	終了	2005 年 6 月 7 日
信頼性試験 - 試料構成詳細				
ID:	Device10	Device11	Device12	
Qual Device:	TPS61040DBV(BOAC)	BQ2022DBZ	REF2912AIDBZ	
Assembly Site:	NSE	NSE	NSE	
Package/Code/Pins:	SOT/DBV/5	SOP/DBZ/3	SOP/DBZ/3	
Mount Compound:	PZ0013	PZ0001	PZ0001	
Mold Compound:	R-13	R-13	R-13	
Leadframe finish:	NiPdAu	NiPdAu	NiPdAu	
ID:	Device13	Device14	Device15	
Qual Device:	UCC2809PW-2	TPS2491DGS	TPS60300DGS	
Assembly Site:	NSE	NSE	NSE	
Package/Code/Pins:	TSSOP/PW/8	VSSOP/DGS/10	VSSOP/DGS/10	
Mount Compound:	PZ0013	PZ0013	PZ0013	
Mold Compound:	R-13	R-13	R-13	
Leadframe finish:	NiPdAu	NiPdAu	NiPdAu	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device10	Device11	Device12
Life Test	150C, 300Hrs.	-	-	120/0
	155C, 240Hrs.	-	348/0	-
	140C, 480Hrs.	120/0	-	-
HAST	130C/85%RH, 96 Hrs.	231/0	231/0	80/0
Autoclave	121C, 240 Hrs.	231/0	231/0	85/0
Thermal Shock	-65C/150C, 1000 cycles	231/0	231/0	95/0
Temp Cycle	-65C/150C, 1000 cycles	231/0	231/0	89/0
High-Temp Storage	170C, 420 Hrs.	231/0	231/0	-
X-Ray	Top side	Approved	Note(1)	Approved
Lead Fatigue	-	Approved	Approved	Approved
Solvent Resistance	-	Approved	Approved	Note(1)
Solderability	8 hr steam age/flux/Dip	Approved	Approved	Approved
Physical Dimensions	Per mechanical drawing	Approved	Approved	Approved
Flammability	UL94 Class V-0	Approved	Approved	Approved
Visual/Mechanical	-	Note(1)	Approved	Approved
Salt Atmosphere	24 Hrs.	Approved	Approved	Approved
Manufacturability (MQ)	Assembly Site	Approved	Approved	Approved
Moisture Sensitivity	JEDEC L-1/260C	Approved	Approved	Approved*
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Device13	Device14	Device15
Life Test	125C, 1000Hrs.	348/0	-	-
	150C, 300Hrs.	-	-	120/0
	155C, 240Hrs.	-	348/0	-
HAST	130C/85%RH, 96 Hrs.	231/0	231/0	120/0
Autoclave	121C, 96 Hrs.	231/0	-	-
	121C, 240 Hrs.	-	231/0	231/0
Thermal Shock	-65C/150C, 1000 cycles	-	231/0	231/0
Temp Cycle	-65C/150C, 1000 cycles	231/0	231/0	231/0
High-Temp Storage	170C, 420 Hrs.	-	231/0	78/0
	150C, 1000Hrs.	135/0	-	-
X-Ray	Top side	Approved	Approved	Note(1)
Lead Fatigue	-	Approved	Approved	Note(1)
Solvent Resistance	-	Note(1)	Approved	Note(1)
Solderability	8 hr steam age/flux/Dip	Approved	Approved	Note(1)
Physical Dimensions	Per mechanical drawing	Approved	Approved	Note(1)
Flammability	UL94 Class V-0	Approved	Approved	Note(1)
Visual/Mechanical	-	Approved	Approved	Note(1)
Salt Atmosphere	24 Hrs.	Approved	Approved	Note(1)
Manufacturability (MQ)	Assembly Site	Approved	Approved	Approved
Moisture Sensitivity	JEDEC L-1/260C	-	-	Approved
Moisture Sensitivity	JEDEC L-2/260C	Approved	Approved	-
Notes:				
* This device was previously classified at JEDEC L-2/260C. Subsequent testing has shown that this device is now classified at JEDEC L-1/260C.				
(1) NSE package qual data has been utilized				

Reference Qual #13

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 12 月 1 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS54327DDA	-	-	
Assembly Site:	ASE SHANGHAI	Package/Code/Pins:	HSOP/DDA/8	
Mount Compound:	EY1000063	Mold Compound:	EN2000509	
Bond Wire:	2.0 mil Dia., Cu	Leadframe (Finish, Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp Operating Life	125C, 1000 Hrs	26/0	26/0	26/0
Electrical Characterization	-	30/0	30/0	30/0
**Biased Temp Humidity	85C/85%RH, 1000 Hrs	26/0	26/0	26/0
**High Temp Storage Bake	150C, 1000 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Bond Strength	76 ball bonds, min. 3 units	76/0	76/0	76/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
**Thermal Shock	-65C/150C, 200 Cyc	77/0	77/0	77/0
X-ray	top side only	5/0	5/0	5/0
Moisture Sensitivity Level	JEDEC L-2/260C	12/0	12/0	12/0
Notes: ** Tests require preconditioning sequence: JEDEC L-2/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 12 月 1 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS54327DDA ES1.1	-	-	
Assembly Site:	ASE SHANGHAI	Package/Code/Pins:	HSOP/DDA/8	
Mount Compound:	EY1000063	Mold Compound:	EN2000509	
Bond Wire:	2.0 mil Dia., Cu	Leadframe (Finish, Base):	NiPdAu, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
Electrical Characterization	-		30/0	
**T/C	-65C/150C, 500 Cyc		77/0	
ESD CDM	500V		3/0	
Manufacturability	per mfg. Site specification		Approved	
X-ray	top side only		5/0	
Notes: ** Tests require preconditioning sequence: JEDEC L-2/260C				

Reference Qual #14

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 4 月 8 日
信頼性試験 - 試料構成詳細				
Qual Device:	PGA308AIDGS	-	-	
Assembly Site:	ASE SHANGHAI	Package/Code/Pins:	VSSOP/DGS/10	
Mount Compound:	EY1000063	Mold Compound:	EN2000515	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAuAg, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**Life Test	150C, 300 Hrs	77/0	77/0	77/0
**High Temp. Storage Bake	170C, 420 Hrs	77/0	77/0	77/0
**Biased HAST	130C/85%RH, 96 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	77/0	77/0	77/0
Backgrind Characterization	-	Approved	-	-
Visual / Mechanical	-	Approved	Approved	Approved
Solderability	Steam age, 8 hours	22/0	22/0	22/0
Lead Fatigue	-	22/0	22/0	22/0
Lead Pull	To destruction	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Physical Dimensions	per mechanical drawing	5/0	5/0	5/0
Flammability	Method A - UL94-0	5/0	5/0	5/0
Flammability	Method B - IEC 695-2-2	5/0	5/0	5/0
Flammability	Method C - UL 1694	5/0	5/0	5/0
Ball Bond Shear	Wires	80/0	80/0	80/0
Bond Pull	Wires	80/0	80/0	80/0
Die Shear	-	15/0	15/0	15/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
**Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Salt Atmosphere	24 Hrs	22/0	22/0	22/0
X-ray	top side only	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Note: ** Preconditioning sequence: JEDEC L-1/260C				

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信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 4 月 8 日
信頼性試験 - 試料構成詳細				
Qual Device:	THS4304DGK	-	-	
Assembly Site:	ASE (Shanghai)	Package/Code/Pins:	MSOP/DGK/8	
Mount Compound:	EY1000063	Mold Compound:	EN2000515	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAuAg, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**Life Test	155C, 240 Hrs	77/0	77/0	77/0
**High Temp. Storage Bake	170C, 420 Hrs	77/0	77/0	77/0
**Biased HAST	130C/85%RH, 96 Hrs	77/0	77/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	77/0
**T/C	-65C/150C, 500 Cyc	82/0	82/0	82/0
Backgrind Characterization	-	Approved	-	-
Visual / Mechanical	-	Approved	Approved	Approved
Surface Mount Solderability	Steam age, 8 hours	22/0	22/0	22/0
Surface Mount Solderability	PB-Free solder	22/0	22/0	22/0
Lead Fatigue	-	22/0	22/0	22/0
Lead Pull	To destruction	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Physical Dimensions	per mechanical drawing	20/0	-	-
Ball Bond Shear	Wires	80/0	80/0	80/0
Bond Pull	Wires	80/0	80/0	80/0
Die Shear	-	15/0	15/0	15/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
**Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Salt Atmosphere	24 Hrs	22/0	22/0	22/0
X-ray	top side only	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Note: ** Preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 4 月 8 日
信頼性試験 - 試料構成詳細				
Qual Device:	TLV2545IDGK	-	-	
Assembly Site:	ASE (Shanghai)	Package/Code/Pins:	MSSOP/DGK/8	
Mount Compound:	EY1000063	Mold Compound:	EN2000515	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAuAg, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp. Storage Bake	170C, 420hrs Hrs	76/0	77/0	84/0
**Autoclave	121C, 96 Hrs	76/0	77/0	84/0
**T/C	-65C/150C, 500 Cyc	82/0	82/0	89/0
Backgrind Characterization	-	Approved	-	-
Visual / Mechanical	-	Approved	Approved	Approved
Surface Mount Solderability	Steam age, 8 hours	22/0	22/0	22/0
Surface Mount Solderability	PB-Free solder	22/0	22/0	22/0
Lead Fatigue	-	22/0	22/0	22/0
Lead Pull	To destruction	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Ball Bond Shear	Wires	80/0	80/0	80/0
Bond Pull	Wires	80/0	80/0	80/0
Die Shear	-	15/0	15/0	15/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
**Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Salt Atmosphere	24 Hrs	22/0	22/0	22/0
X-ray	top side only	5/0	5/0	5/0
Moisture Sensitivity	JEDEC L-1/260C	12/0	12/0	12/0
Note: ** Preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 4 月 8 日
信頼性試験 - 試料構成詳細				
Qual Device:	TPS62040DGQ	-	-	
Assembly Site:	ASE (Shanghai)	Package/Code/Pins:	MSOP/DGQ/10	
Mount Compound:	EY1000063	Mold Compound:	EN2000515	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAuAg, Cu	
MSL:	JEDEC L-1/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration	Sample Size/ Fails		
		Lot #1	Lot #2	Lot #3
**High Temp. Storage Bake	170C, 420 Hrs	76/0	77/0	73/0
**Biased HAST	130C/85%RH, 96 Hrs	77/0	70/0	77/0
**Autoclave	121C, 96 Hrs	77/0	77/0	70/0
**T/C	-65C/150C, 500 Cyc	78/0	81/0	80/0
Visual / Mechanical	-	Approved	Approved	Approved
Surface Mount Solderability	Steam age, 8 hours	22/0	22/0	22/0
Surface Mount Solderability	PB-Free solder	22/0	22/0	22/0
Lead Fatigue	-	22/0	22/0	22/0
Lead Pull	To destruction	22/0	22/0	22/0
Lead Finish Adhesion	-	15/0	15/0	15/0
Physical Dimensions	per mechanical drawing	20/0	--	--
Flammability	Method A - UL94-0	5/0	5/0	5/0
Flammability	Method B - IEC 695-2-2	5/0	5/0	5/0
Flammability	Method C - UL 1694	5/0	5/0	5/0
Ball Bond Shear	Wires	80/0	76/0	76/0
Bond Pull	Wires	80/0	76/0	76/0
Die Shear	-	15/0	15/0	15/0
Manufacturability (Assembly)	per mfg. Site specification	Approved	Approved	Approved
**Thermal Shock	-65C/150C, 500 Cyc	77/0	77/0	77/0
Salt Atmosphere	24 Hrs	22/0	22/0	22/0
X-ray	top side only	5/0	5/0	--
Moisture Sensitivity	JEDEC L-1/260C	11/0	12/0	9/0
Note: ** Preconditioning sequence: JEDEC L-1/260C				

信頼性試験結果				
信頼性試験期間	開始	—	終了	2010 年 4 月 8 日
信頼性試験 - 試料構成詳細				
Qual Device:	VCA822IDGS	-	-	
Assembly Site:	ASE (Shanghai)	Package/Code/Pins:	MSOP/DGS/10	
Mount Compound:	EY1000063	Mold Compound:	EN2000515	
Bond Wire:	1.0 mil Dia., Au	Leadframe (Finish, Base):	NiPdAuAg, Cu	
MSL:	JEDEC L-2/260C	-	-	
信頼性試験結果				
Reliability Test	Condition / Duration		Sample Size/ Fails	
**High Temp. Storage Bake	170C, 420 Hrs		77/0	
**Autoclave	121C, 96 Hrs		77/0	
**T/C	-65C/150C, 500 Cyc		77/0	
Visual / Mechanical	-		Approved	
**Thermal Shock	-65C/150C, 500 Cyc		77/0	
Solderability	Steam age, 8 hours		22/0	
Ball Bond Shear	Wires		80/0	
Bond Pull	Wires		80/0	
Die Shear	-		15/0	
Manufacturability (Assembly)	per mfg. Site specification		Approved	
Salt Atmosphere	24 Hrs		22/0	
X-ray	top side only		5/0	
Note: ** Preconditioning sequence: JEDEC L-2/260C				